Applications

- 5 GHz WLAN (IEEE802.11a/g/n)
- Access Points, PCMCIA, PC cards

Features

- 5GHz Front End Module with PA, LNA and T/R Switch
- Integrated power amplifier enable pin (V$_{EN}$)
- Buffered, temperature compensated power detector
- High and Low-Linearity mode
- 3% EVM, @17dBm, 64 QAM, 54 Mbps
- 30 dB Typical Gain
- Lead Free and RoHS compliant, halogen free package
- 16 pin 3 mm x 3 mm x 0.6 mm QFN, MSL1

Ordering Information

Part Number	Package	Remark
SE5007T	16 Pin QFN	Samples
SE5007T-R	16 Pin QFN	Tape and Reel
SE5007T-EK1	Evaluation Kit	Standard

Product Description

The SE5007T is a 5GHz front end module offering high linear power for wireless LAN applications. It incorporates a power detector for control of the output power.

The SE5007T offers a high level of integration for a simplified design, providing quicker time to market and higher application board production yield. The device integrates the input match, inter-stage match, a temperature compensated, load insensitive power detector with 20dB of dynamic range, a 3.8GHz notch filter, a T/R switch and LNA.

For wireless LAN applications, the device meets the requirements of IEEE802.11a and delivers approximately 17dBm of linear output power. It also features a low linearity mode control to reduce current consumption at low power modes.

The SE5007T integrates the reference voltage generator, allowing for a true 1.8V CMOS compatible digital EN (enable) function to turn the power amplifier on and off.

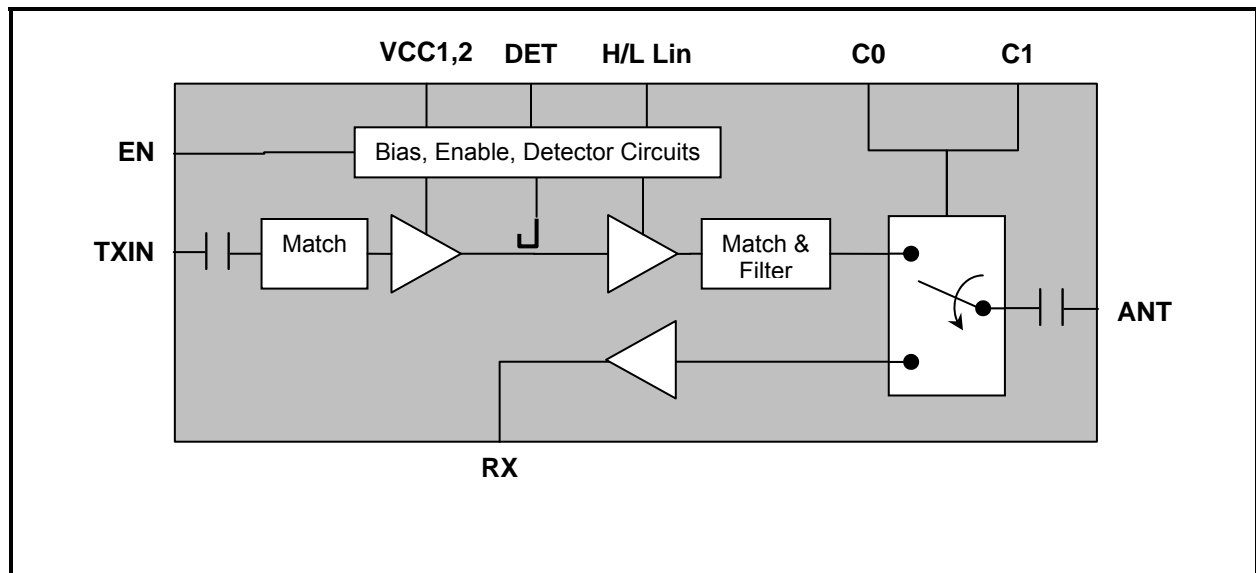## Functional Block Diagram

Figure 1: Functional Block Diagram

DATA SHEET
SE5007T: 5 GHz Front End Module with Power Detector
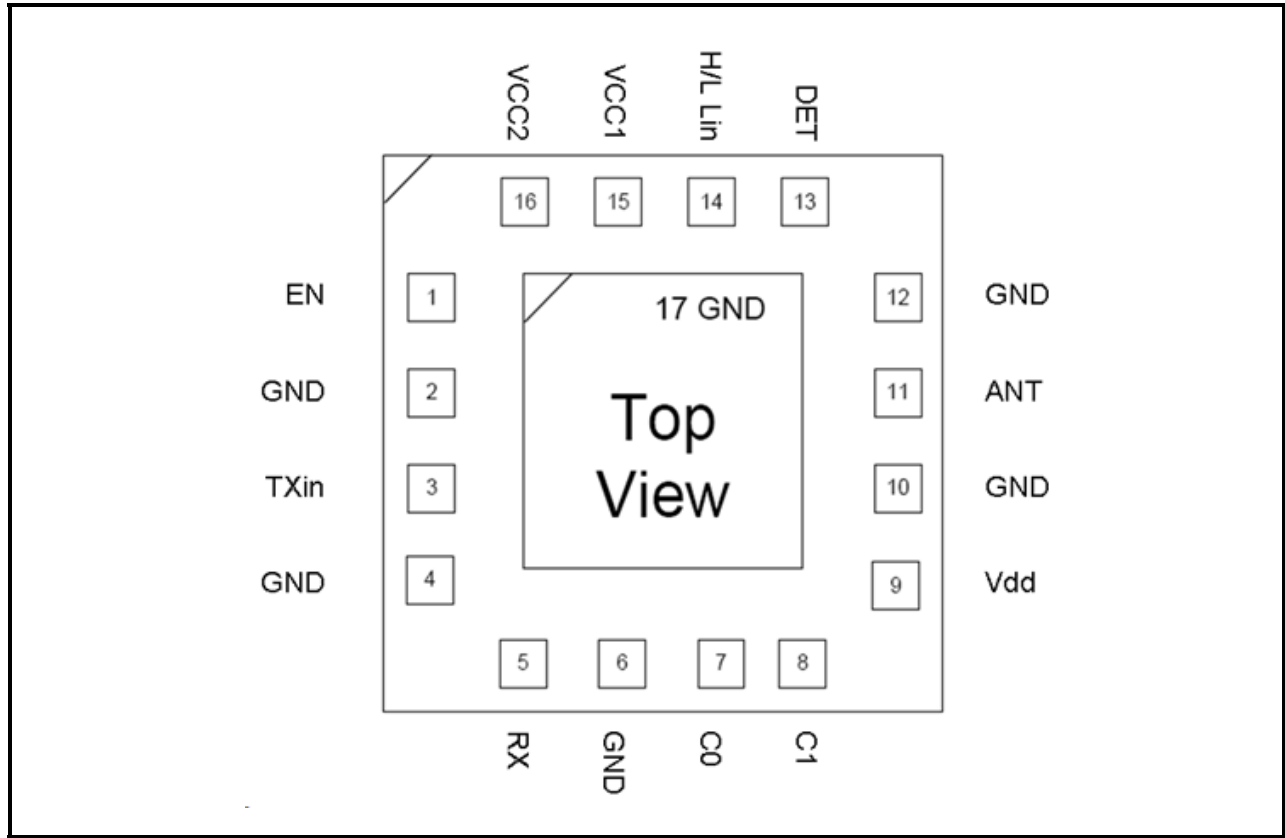
Pin Out Diagram

Figure 2: SE5007T Pin-Out Diagram

Pin Out Description

Pin No.	Name	Description	Pin No.	Name	Description
1	EN	PA Enable	9	VDD	LNA Supply Voltage
2	GND	Ground	10	GND	Ground
3	TXIN	5GHz TX RF Input Signal	11	ANT	5GHz Antenna output
4	GND	Ground	12	GND	Ground
5	RX	5GHz LNA Output Signal	13	DET	Power Detector Output
6	GND	Ground	14	H/L Lin	High-Low linearity Control
7	C0	Switch Control Logic 1	15	VCC1	Power Stage Supply Voltage
8	C1	Switch Control Logic 2	16	VCC2	Bias, Driver Stage Supply Voltage

Absolute Maximum Ratings

These are stress ratings only. Exposure to stresses beyond these maximum ratings for a long period of time may cause permanent damage to, or affect the reliability of the device. Avoid operating the device outside the recommended operating conditions defined below. This device is ESD sensitive. Handling and assembly of this device should be at ESD protected workstations.

Symbol	Definition		Min.	Max.	Unit
V_{CC1}	Supply Voltage on pin 15 (VCC1)		3.0	4.8	V
V_{DD}, V_{CC2}	Supply Voltage on pins 9, 16 (VDD, VCC2)		3.0	3.6	V
EN	DC input on Enable		-0.3	3.6	V
TXIN	RF Input Power, RFout into 50Ω match		-	12	dBm
T_{STG}	Storage Temperature Range		-40	150	°C
ESD $_{HBM}$	JEDEC JESD22-A114 all pins	Antenna Pin	-	1000	V
		All Other Pins	-	300	

Recommended Operating Conditions

Symbol	Parameter	Min.	Max.	Unit
V_{CC1}	Supply Voltage on pin 15 (VCC1)	3.0	4.5	V
V_{DD}, V_{CC2}	Supply Voltage on pins 9, 16 (VDD, VCC2)	3.0	3.6	V
T_A	Ambient Temperature	-40	85	°C

Control Logic Characteristics

Conditions: V_{CC1} = V_{CC2} = V_{DD} = V_{PAON} = V_{EN} = 3.3 V, T_A = 25 °C, as measured on Skyworks Solutions' SE5007T-EV1 evaluation board, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_{CC-802.11a}$	Supply Current, Transmit Mode	P_{OUT} = 17 dBm, 54 Mbps, 64 QAM, H/L Lin = 3.3V (High Linearity Mode)	-	195	-	mA
		P_{OUT} = 13 dBm, 54 Mbps, 64 QAM, H/L Lin = 0V (Low Linearity Mode)	-	140	-	
		P_{OUT} = 5 dBm, 54 Mbps, 64 QAM, H/L Lin = 0V (Low Linearity Mode)	-	105	-	
		P_{OUT} = 19 dBm, 54 Mbps, 64 QAM, H/L Lin = 3.3V, VCC1 = 4.0V		220		
	Supply Current, Receive Mode	V_{EN} = C0 = 0V; C1 = 3.3V		15		
		V_{EN} = C0 = C1 = 0V		0.02		
I_{OFF}	Supply Current	V_{EN} = 0 V, No RF, C0=C1=0 V Measured on VCC, VDD pins	-	20	50	µA
V_{ENH}	Logic High Voltage	-	1.6	-	3.6	V
V_{ENL}	Logic Low Voltage	-	-0.3	-	0.3	V
I_{ENH}	Input Current Logic	-	-	330	400	µA

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
	High Voltage					
I_{ENL}	Input Current Logic Low Voltage	-	-	<1	-	µA

Switch Logic Characteristics

Conditions: $V_{CC} = V_{EN} = 3.3$ V, $T_A = 25$ °C, as measured on Skyworks Solutions' SE5007T-EK1 evaluation board, all unused ports terminated with 50 ohms, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
ON	Low Loss Switch Control Voltage	High State = V_{CTL_ON} - V_{CTL_OFF}	2.8	-	3.6	V
OFF	High Loss Switch Control Voltage	Low State = V_{CTL_OFF} - V_{CTL_OFF}	0	-	0.3	V
C_{CTL}	Control Input Capacitance	-	-	-	100	pF
I_{CTL}	Control Line Current	$V_{CTL} = V_{CTL\_ON}$	-	2	10	uA

Switch Control Logic Table

C0	C1	EN	Hi/L Lin	ANT
ON	OFF	**ON**	OFF	**TX Low Linearity**
ON	OFF	**ON**	**ON**	**TX High Linearity**
OFF	OFF	OFF	D/C	**Rx Bypass**
OFF	**ON**	OFF	D/C	**Rx LNA ON**
ON	**ON**	Un-supported state		

AC Electrical Characteristics

Transmit Characteristics

Conditions: $V_{CC1} = V_{CC2} = V_{DD} = V_{EN} = C0 = H/L \ Lin = 3.3V$, C1 = 0V, T_A = 25 °C, as measured on Skyworks Solutions' SE5007T-EV1 evaluation board, unless otherwise noted

Symbol	Parameter	Conditions		Min.	Typ.	Max.	Unit
f_{L-U}	Frequency Range	-		4.90	-	5.85	GHz
POUT	Output Power, High Linearity Mode H/L Lin = 3.3V OFDM	802.11a, 64 QAM	EVM = 3%	-	17	-	dBm
			EVM = 2%	-	15	-	
		VCC1 = 4.0V, 3% EVM	EVM = 3%	-	19	-	
		MCS0, HT20, mask compliant		-	21	-	
		MCS0, HT40, mask compliant		-	20	-	
	Output Power, Low Linearity Mode H/L Lin = 0V OFDM	802.11a, 64 QAM, EVM = 3%		-	13	-	
		MCS0, HT20, mask compliant		-	17	-	
		MCS0, HT40, mask compliant		-	16	-	
P_{1dB}	Output 1dB compression point	No modulation		-	24	-	dBm
S_{11}	Input Return Loss	P_{IN} = -25 dBm		-	14	-	dB
S_{21}	Small Signal Gain, P_{IN} = -25dBm	High Linearity Mode		28	31	-	dB
		Low Linearity Mode		26	30	-	
ΔS_{21}	Small Signal Gain Variation	Gain variation over single 40MHz channel		-	-	0.5	dB
		Gain Variation over band		-1.5	-	1.5	
$S_{21\_3.8}$	Out of Band Gain	Gain at 3.8GHz		-	-	15	dB
2f	Harmonic	P_{OUT} = 17 dBm, OFDM		-	-50	-42	dBm/MHz
3f				-	-50	-42	
t_r, t_f	Rise and Fall Time	-		-	0.5	-	us
STAB	Stability	P_{OUT} = 17 dBm, 54 Mbps, 64 QAM, VSWR = 6:1, all phases		All non-harmonically related outputs less than -50 dBc/100 kHz			
Rugged-ness	Tolerance to output load mismatching	Constant P_{IN} equal to P_{OUT} = 17 dBm at 50ohms, 54 Mbps, 64 QAM, VSWR = 6:1, all phases		No damage			
Robust	Robustness to input power	P_{IN} = 12dBm, CW, VSWR = 6:1, all phases		No damage			

Receive Characteristics

Conditions: V_{CC} = C1 = 3.3V, V_{EN} = C0 = 0V, T_A = 25 °C, as measured on Skyworks Solutions' SE5007T-EK1 evaluation board, all unused ports terminated with 50 ohms, unless otherwise noted.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
F_{OUT}	Frequency Range	-	4.9	-	5.85	GHz
RX	Insertion Loss	Bypass Mode: C0 = C1 = 0V	-	-5	-	dB
	RX Gain	High Gain Mode	11	12	-	
NF	Noise Figure	High Gain Mode	-	2.5	-	dB
RX_{RL}	Input Return Loss	At the Antenna port	-	12	-	dB
	Output Return Loss	At RX RF output	-	7	-	
RxIP1DB	Input P1DB	Measured at ANT Port; High Gain Mode	-	-5	-	dBm
		LNA Bypass Mode	-	10	-	
Rx_2.4int	Max 2.4Ghz interferer Amplitude	1 dB degradation of IP1DB	-	-10	-7	dBm
$T_{on/off}$	T/R on/off switching speed	C0, C1 (50%) to RF output (10% or 90%)	-	300	-	nSec

Power Detector Characteristics

Conditions: $V_{CC} = V_{EN} = C0 = 3.3V$, C1 = 0V, f = 5.4 GHz, T_A = 25 °C, as measured on Skyworks Solutions'
SE5007T-EV1 evaluation board, unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
PDR	P_{OUT} detect range	-	0	-	P_{1dB}	dBm
$VDET_{22}$	Detector voltage	P_{OUT} = 22 dBm	0.7	-	0.9	V
$VDET_{16}$	Detector voltage	P_{OUT} = 16 dBm	0.50	-	0.60	V
$VDET_2$	Detector voltage	P_{OUT} = 2 dBm	0.25	-	0.35	V
PDZ_{OUT}	Output Impedance	-	-	5	-	KΩ
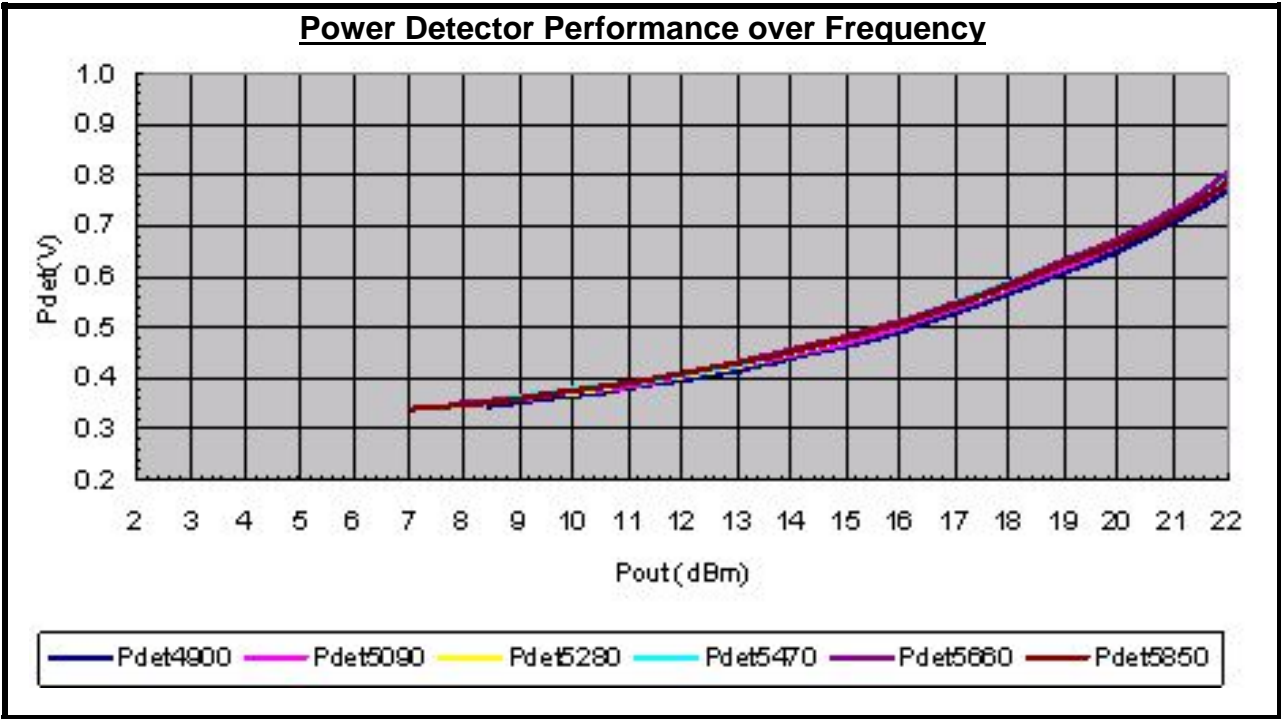
Figure 3: SE5007T Power Detector Characteristic

Package Diagram

This package is Pb free and RoHS compliant. The product is rated MSL1.
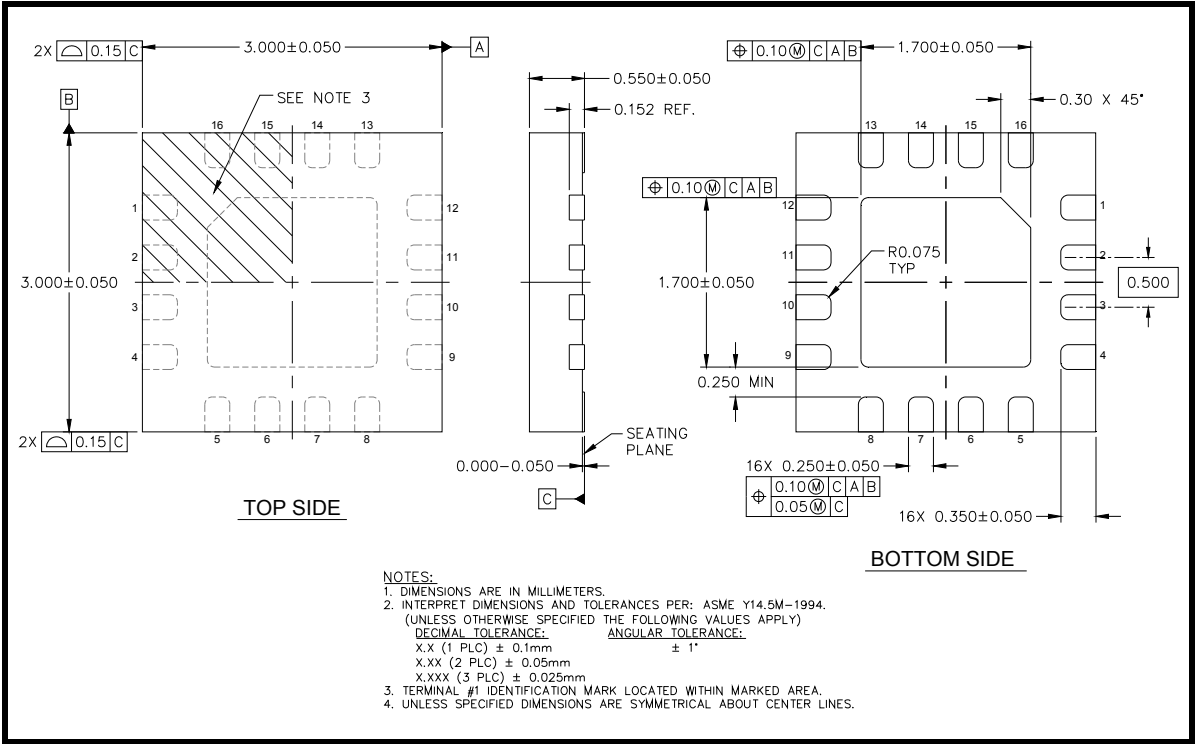
Figure 4: SE5007T Package Diagram

Recommended Land and Solder Patterns
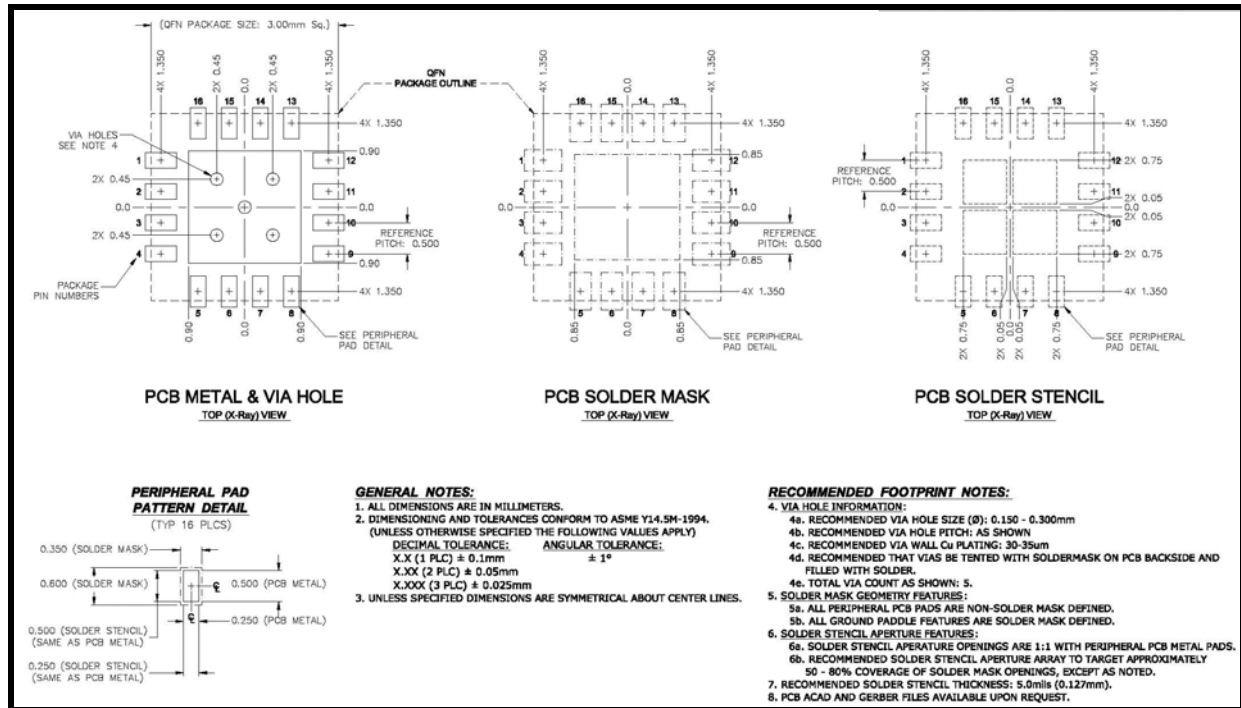
Figure 5: SE5007T Recommended Land and Solder Pattern

Package Handling Information

Because of its sensitivity to moisture absorption, instructions on the shipping container label must be followed regarding exposure to moisture after the container seal is broken, otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly. The SE5007T is capable of withstanding a Pb free solder reflow. Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. If the part is manually attached, precaution should be taken to insure that the device is not subjected to temperatures above its rated peak temperature for an extended period of time. For details on both attachment techniques, precautions, and handling procedures recommended, please refer to:

- "Quad Flat No-Lead Module Solder Reflow & Rework Information", *Document Number QAD-00045*
- "Handling, Packing, Shipping and Use of Moisture Sensitive QFN", *Document Number QAD-00044*

Caution! Class 1A ESD sensitive device

Branding Information
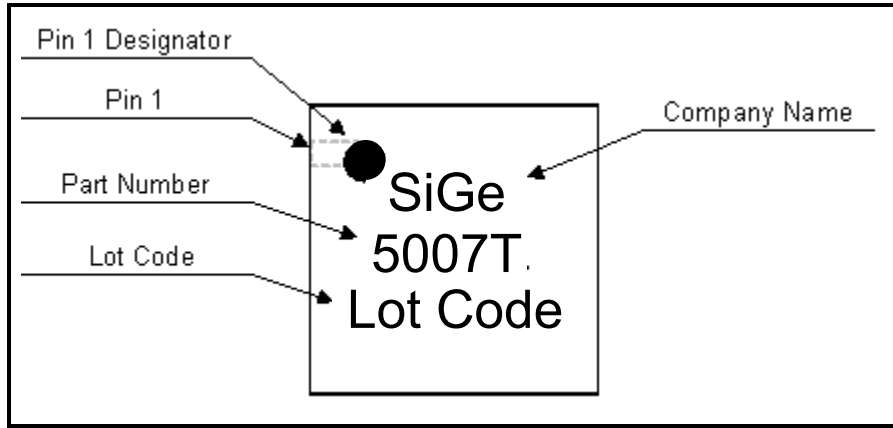
Figure 6: SE5007T Branding

Tape and Reel Information

Parameter	Value
Devices Per Reel	3000
Reel Diameter	13 inches
Tape Width	12 millimeters
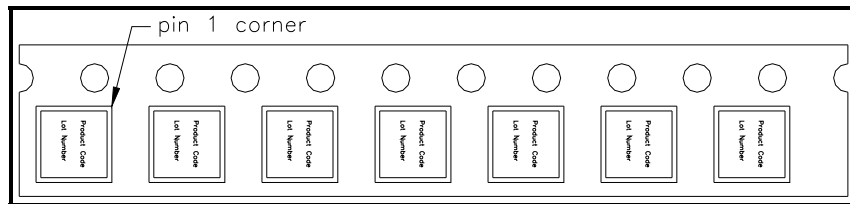
Figure 7: SE5007T-R Tape and Reel Information

Document Change History

Revision	Date	Notes
1.0	Jun 24, 2010	Created
1.1	Jul 2, 2010	Corrected control logic table
1.2	Jul 7, 2010	Expanded frequency range to 4.9GHz to 5.85GHz Expanded operating temperature range to -40 to +85 Changed VDD supply from 2.5V to 3.3V $\pm$ 10%
1.3	Jul 14, 2010	Removed reference to incorrect part number.
1.4	Sep 30, 2010	Updated RX output return loss (S22) limit
1.5	Oct 05, 2010	Updated the Block Diagram
1.6	Dec 20, 2010	Corrected RX Conditions in Control Logic table

Revision	Date	Notes
1.7	Jan 03, 2011	Update recommended storage temperature. Updated ESD rating Updated max limit on VCC2
1.8	Feb 8, 2011	Added 4V operation
1.9	Apr 25, 2011	Update V_{ENH} min spec from 2.8V to 1.6V
2.0	Apr 03, 2012	Updated with Skyworks logo and disclaimer statement